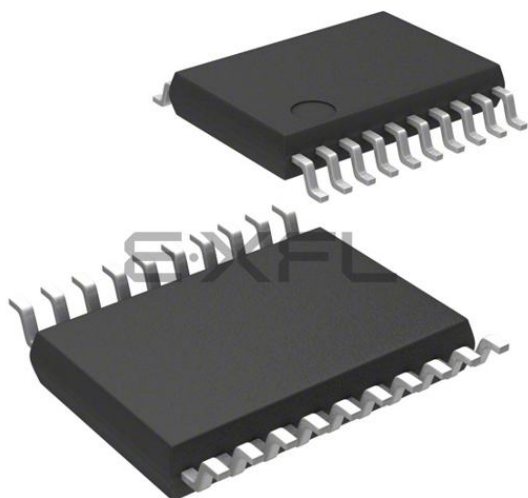




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Details

Product Status	Not For New Designs
Core Processor	STM8A
Core Size	8-Bit
Speed	16MHz
Connectivity	I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	16
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	640 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 5x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 150°C (TA)
Mounting Type	Surface Mount
Package / Case	20-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	20-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/stmicroelectronics/stm8af6223pdx

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4.5 Clock controller

The clock controller distributes the system clock (f_{MASTER}) coming from different oscillators to the core and the peripherals. It also manages clock gating for low-power modes and ensures clock robustness.

4.5.1 Features

- **Clock prescaler:** to get the best compromise between speed and current consumption the clock frequency to the CPU and peripherals can be adjusted by a programmable prescaler.
- **Safe clock switching:** Clock sources can be changed safely on the fly in Run mode through a configuration register. The clock signal is not switched until the new clock source is ready. The design guarantees glitch-free switching.
- **Clock management:** To reduce power consumption, the clock controller can stop the clock to the core, individual peripherals or memory.
- **Master clock sources:** four different clock sources can be used to drive the master clock:
 - 1-16 MHz high-speed external crystal (HSE)
 - Up to 16 MHz high-speed user-external clock (HSE user-ext)
 - 16 MHz high-speed internal RC oscillator (HSI)
 - 128 kHz low-speed internal RC (LSI)
- **Startup clock:** after reset, the microcontroller restarts by default with an internal 2 MHz clock (HSI/8). The prescaler ratio and clock source can be changed by the application program as soon as the code execution starts.
- **Clock security system (CSS):** this feature can be enabled by software. If an HSE clock failure occurs, the internal RC (16 MHz/8) is automatically selected by the CSS and an interrupt can optionally be generated.
- **Configurable main clock output (CCO):** This outputs an external clock for use by the application.

Table 2. Peripheral clock gating bit assignments in CLK_PCKENR1/2 registers

Bit	Peripheral clock	Bit	Peripheral clock	Bit	Peripheral clock	Bit	Peripheral clock
PCKEN17	TIM1	PCKEN13	LINUART	PCKEN27	Reserved	PCKEN23	ADC
PCKEN16	TIM5	PCKEN12	Reserved	PCKEN26	Reserved	PCKEN22	AWU
PCKEN15	Reserved	PCKEN11	SPI	PCKEN25	Reserved	PCKEN21	Reserved
PCKEN14	TIM6	PCKEN10	I ² C	PCKEN24	Reserved	PCKEN20	Reserved

4.6 Power management

For efficient power management, the application can be put in one of four different low-power modes. Users can configure each mode to obtain the best compromise between lowest power consumption, fastest start-up time and available wakeup sources.

- **Wait mode:** in this mode, the CPU is stopped but peripherals are kept running. The wakeup is performed by an internal or external interrupt or reset.
- **Active-halt mode with regulator on:** in this mode, the CPU and peripheral clocks are stopped. An internal wakeup is generated at programmable intervals by the auto wake up unit (AWU). The main voltage regulator is kept powered on, so current consumption is higher than in Active-halt mode with regulator off, but the wakeup time is faster. Wakeup is triggered by the internal AWU interrupt, external interrupt or reset.
- **Active-halt mode with regulator off:** this mode is the same as Active-halt with regulator on, except that the main voltage regulator is powered off, so the wake up time is slower.
- **Halt mode:** in this mode the microcontroller uses the least power. The CPU and peripheral clocks are stopped, the main voltage regulator is powered off. Wakeup is triggered by external event or reset.

4.7 Watchdog timers

The watchdog system is based on two independent timers providing maximum security to the applications.

Activation of the watchdog timers is controlled by option bytes or by software. Once activated, the watchdogs cannot be disabled by the user program without performing a reset.

Window watchdog timer

The window watchdog is used to detect the occurrence of a software fault, usually generated by external interferences or by unexpected logical conditions, which cause the application program to abandon its normal sequence.

The window function can be used to trim the watchdog behavior to match the application timing perfectly. The application software must refresh the counter before time-out and during a limited time window.

A reset is generated in two situations:

1. **Timeout:** at 16 MHz CPU clock the time-out period can be adjusted between 75 μ s up to 64 ms.
2. **Refresh out of window:** the downcounter is refreshed before its value is lower than the one stored in the window register.

4.13 Analog-to-digital converter (ADC1)

The STM8AF6213, STM8AF6223, STM8AF6223A and STM8AF6226 products contain a 10-bit successive approximation A/D converter (ADC1) with up to 7 external and 1 internal multiplexed input channels and the following main features:

- Input voltage range: 0 to V_{DD}
- Input voltage range: 0 to V_{DDA}
- Conversion time: 14 clock cycles
- Single and continuous and buffered continuous conversion modes
- Buffer size ($n \times 10$ bits) where n = number of input channels
- Scan mode for single and continuous conversion of a sequence of channels
- Analog watchdog capability with programmable upper and lower thresholds
- Internal reference voltage on channel AIN7
- Analog watchdog interrupt
- External trigger input
- Trigger from TIM1 TRGO
- End of conversion (EOC) interrupt

Note: Additional AIN12 analog input is not selectable in ADC scan mode or with analog watchdog. Values converted from AIN12 are stored only into the ADC_DRH/ADC_DRL registers.

Internal bandgap reference voltage

Channel AIN7 is internally connected to the internal bandgap reference voltage. The internal bandgap reference is constant and can be used, for example, to monitor V_{DD} . It is independent of variations in V_{DD} and ambient temperature T_A .

4.14 Communication interfaces

The following communication interfaces are implemented:

- LINUART: Full feature UART, synchronous mode, SPI master mode, Smartcard mode, IrDA mode, single wire mode, LIN2.2 capability
- SPI: full and half-duplex, 8 Mbit/s
- I²C: up to 400 Kbit/s

Some peripheral names differ between the datasheet and STM8S series and STM8AF series 8-bit microcontrollers reference manual, RM0016 (see [Table 4](#)).

Table 4. Communication peripheral naming correspondence

Peripheral name in datasheet	Peripheral name in reference manual (RM0016)
LINUART	UART4

5 Pinout and pin description

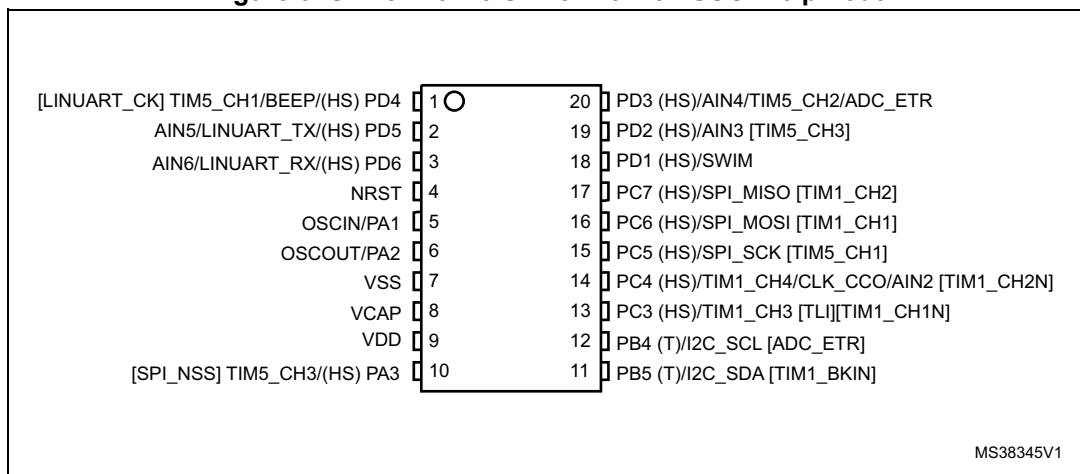
The following table presents the meaning of the abbreviations in use in the pin description tables in this section.

Table 5. Legend/abbreviations for pinout tables

Type	I= input, O = output, S = power supply	
Level	Input	CM = CMOS (standard for all I/Os)
	Output	HS = High sink
Output speed	O1 = Slow (up to 2 MHz) O2 = Fast (up to 10 MHz) O3 = Fast/slow programmability with slow as default state after reset O4 = Fast/slow programmability with fast as default state after reset	
Port and control configuration	Input	float = floating, wpu = weak pull-up
	Output	T = true open drain, OD = open drain, PP = push pull
Reset state	Bold X (pin state after internal reset release). Unless otherwise specified, the pin state is the same during the reset phase and after the internal reset release.	

5.1 TSSOP20 pinouts and pin descriptions

Figure 3. STM8AF6213/STM8AF6223 TSSOP20 pinout



1. (HS) high sink capability.
2. (T) true open drain (P-buffer and protection diode to V_{DD} not implemented).
3. [] alternate function remapping option (if the same alternate function is shown twice, it indicates an exclusive choice not a duplication of the function).

Table 6. STM8AF6213/STM8AF6223 TSSOP20 pin description (continued)

TSSOP	Pin name	Type	Input			Output				Main function (after reset)	Default alternate function	Alternate function after remap [option bit]
			floating	wpu	Ext. interrupt	High sink ⁽¹⁾	Speed	OD	PP			
10	PA3/ TIM5_CH3 [SPI_NSS]	I/O	X	X	X	HS	O3	X	X	Port A3	Timer 5 channel 3	SPI master/slave select [AFR1]
11	PB5/ I2C_SDA [TIM1_BKIN]	I/O	X	-	X	-	O1	T ⁽³⁾	-	Port B5	I2C data	Timer 1 - break input [AFR4]
12	PB4/ I2C_SCL [ADC_ETR]	I/O	X	-	X	-	O1	T ⁽³⁾	-	Port B4	I2C clock	ADC external trigger [AFR4]
13	PC3/ TIM1_CH3/[TLI]/[TIM1_CH1N]	I/O	X	X	X	HS	O3	X	X	Port C3	Timer 1 - channel 3	Top level interrupt [AFR3] Timer 1 inverted channel 1 [AFR7]
14	PC4/ TIM1_CH4/CLK_CCO/AIN2/[TIM1_CH2N]	I/O	X	X	X	HS	O3	X	X	Port C4	Timer 1 - channel 4 /configurable clock output	Analog input 2 [AFR2] Timer 1 inverted channel 2 [AFR7]
15	PC5/SPI_SCK [TIM5_CH1]	I/O	X	X	X	HS	O3	X	X	Port C5	SPI clock	Timer 5 channel 1 [AFR0]
16	PC6/ SPI_MOSI [TIM1_CH1]	I/O	X	X	X	HS	O3	X	X	Port C6	PI master out/slave in	Timer 1 channel 1 [AFR0]
17	PC7/ SPI_MISO [TIM1_CH2]	I/O	X	X	X	HS	O3	X	X	Port C7	SPI master in/ slave out	Timer 1 channel 2 [AFR0]
18	PD1/ SWIM ⁽⁴⁾	I/O	X	X	X	HS	O4	X	X	Port D1	SWIM data interface	-

Table 6. STM8AF6213/STM8AF6223 TSSOP20 pin description (continued)

TSSOP	Pin name	Type	Input			Output				Main function (after reset)	Default alternate function	Alternate function after remap [option bit]
			floating	wpu	Ext. interrupt	High sink ⁽¹⁾	Speed	OD	PP			
19	PD2/AIN3 [TIM5_CH3]	I/O	X	X	X	HS	O3	X	X	Port D2	-	Analog input 3 [AFR2] Timer 52 - channel 3 [AFR1]
20	PD3/ AIN4/ TIM5_CH2/ ADC_ETR	I/O	X	X	X	HS	O3	X	X	Port D3	Analog input 4 Timer 52 - channel 2/ADC external trigger	-

1. I/O pins used simultaneously for high current source/sink must be uniformly spaced around the package. In addition, the total driven current must respect the absolute maximum ratings (see [Section 9.2: Absolute maximum ratings](#)).
2. When the MCU is in Halt/Active-halt mode, PA1 is automatically configured in input weak pull-up and cannot be used for waking up the device. In this mode, the output state of PA1 is not driven. It is recommended to use PA1 only in input mode if Halt/Active-halt is used in the application.
3. In the open-drain output column, 'T' defines a true open-drain I/O (P-buffer, weak pull-up, and protection diode to VDD are not implemented)
4. The PD1 pin is in input pull-up during the reset phase and after internal reset release.

Table 7. STM8AF6223A TSSOP20 pin description

TSSOP	Pin name	Type	Input			Output				Main function (after reset)	Default alternate function	Alternate function after remap [option bit]
			floating	wpu	Ext. interrupt	High sink ⁽¹⁾	Speed	OD	PP			
1	PD4/ TIM5_CH1/ BEEP/SPI_NSS [LINUART_CK]	I/O	X	X	X	HS	O3	X	X	Port D4	Timer 5 - channel 1/BEEP output	LINUART clock [AFR2]
2	PD5/ AIN5/ LINUART_TX	I/O	X	X	X	HS	O3	X	X	Port D5	Analog input 5/ LINUART data transmit	-

Table 7. STM8AF6223A TSSOP20 pin description (continued)

TSSOP	Pin name	Type	Input			Output				Main function (after reset)	Default alternate function	Alternate function after remap [option bit]
			floating	wpu	Ext. interrupt	High sink ⁽¹⁾	Speed	OD	PP			
3	PD6/ AIN6/ LINUART_RX	I/O	X	X	X	HS	O3	X	X	Port D6	Analog input 6/ LINUART data receive	-
4	NRST	I/O	-	X	-	-	-	-	-	Reset		-
5	PA1/ OSCIN ⁽²⁾	I/O	X	X	X	-	O1	X	X	Port A1	Resonator/ crystal in	-
6	PA2/ OSCOUT	I/O	X	X	X	-	O1	X	X	Port A2	Resonator/ crystal out	-
7	VSS	S	-	-	-	-	-	-	-	Digital ground		-
8	VCAP	S	-	-	-	-	-	-	-	1.8 V regulator capacitor		-
9	VDD	S	-	-	-	-	-	-	-	Digital power supply		-
10	PB5/ I2C_SDA [TIM1_BKIN]	I/O	X	-	X	-	O1	T ⁽³⁾	-	Port B5	I2C data	Timer 1 - break input [AFR4]
11	PB4/ I2C_SCL [ADC_ETR]	I/O	X	-	X	-	O1	T ⁽³⁾	-	Port B4	I2C clock	ADC external trigger [AFR4]
12	PB1/ TIM1_CH2N/ AIN1	I/O	X	X	X	HS	O3	X	X	Port B1	Timer 1 - inverted channel 2/Analog input 1	-
13	PB0/ TIM1_CH1N/AIN0	I/O	X	X	X	HS	O3	X	X	Port B0	Timer 1 - inverted channel 1/Analog input 0	-
14	PC4/ TIM1_CH4/ CLK_CCO/AIN2/[TIM1_CH2]	I/O	X	X	X	HS	O3	X	X	Port C4	Timer 1 - channel 4 /configurable clock output	Analog input 2 [AFR2]Timer 1 channel 2 [AFR7]
15	PC5/SPI_SCK [TIM5_CH1]	I/O	X	X	X	HS	O3	X	X	Port C5	SPI clock	Timer 5 channel 1 [AFR0]

Table 8. STM8AF6226 LQFP32/VFQPN32 pin description (continued)

LQFP32 VFQPN32	Pin name	Type	Input			Output				Main function (after reset)	Default alternate function	Alternate function after remap [option bit]
			floating	wpu	Ext. interrupt	High sink ⁽¹⁾	Speed	OD	PP			
4	VSS	S	-	-	-	-	-	-	-	Digital ground		-
5	VCAP	S	-	-	-	-	-	-	-	1.8 V regulator capacitor		-
6	VDD	S	-	-	-	-	-	-	-	Digital power supply		-
7	PA3/ TIM5_CH3 [SPI_NSS] [LINUART_TX]	I/O	<u>X</u>	X	X	HS	O3	X	X	Port A3	Timer 52 channel 3	SPI master/ slave select [AFR1]/ LINUART data transmit [AFR1:0]
8	PF4 [LINUART_RX]	I/O	<u>X</u>	X	-	-	O1	X	X	Port F4	LINUART data receive [AFR1:0]	-
9	PB7	I/O	<u>X</u>	X	X	-	O1	X	X	Port B7	-	-
10	PB6	I/O	<u>X</u>	X	X	-	O1	X	X	Port B6	-	-
11	PB5/ I2C_SDA [TIM1_BKIN]	I/O	<u>X</u>	-	X	-	O1	T ⁽³⁾	-	Port B5	I2C data	Timer 1 - break input [AFR4]
12	PB4/ I2C_SCL [ADC_ETR]	I/O	<u>X</u>	-	X	-	O1	T ⁽³⁾	-	Port B4	I2C clock	ADC external trigger [AFR4]
13	PB3/ AIN3/TIM1_ET R	I/O	<u>X</u>	X	X	HS	O3	X	X	Port B3	Analog input 3/ Timer 1 external trigger	-
14	PB2/ AIN2/ TIM1_CH3N	I/O	<u>X</u>	X	X	HS	O3	X	X	Port B2	Analog input 2/ Timer 1 - inverted channel 3	-
15	PB1/ AIN1/ TIM1_CH2N	I/O	<u>X</u>	X	X	HS	O3	X	X	Port B1	Analog input 1/ Timer 1 - inverted channel 2	-
16	PB0/ AIN0/ TIM1_CH1N	I/O	<u>X</u>	X	X	HS	O3	X	X	Port B0	Analog input 0/ Timer 1 - inverted channel 1	-

6 Memory and register map

6.1 Memory map

Figure 6. Memory map

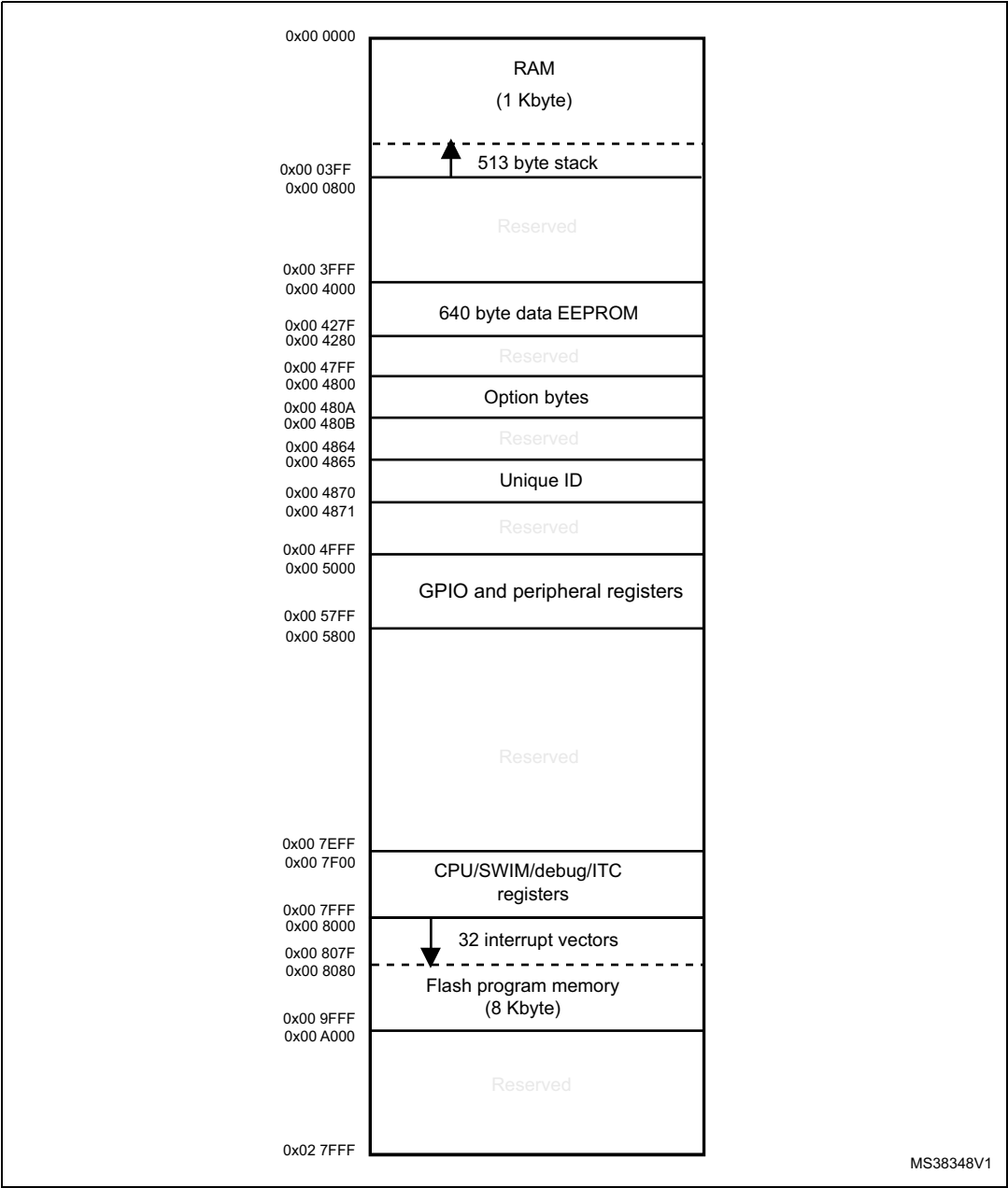


Table 10. I/O port hardware register map (continued)

Address	Block	Register label	Register name	Reset status
0x00 5014	Port E	PE_ODR	Port E data output latch register	0x00
0x00 5015		PE_IDR	Port E input pin value register	0xXX ⁽¹⁾
0x00 5016		PE_DDR	Port E data direction register	0x00
0x00 5017		PE_CR1	Port E control register 1	0x00
0x00 5018		PE_CR2	Port E control register 2	0x00
0x00 5019	Port F	PF_ODR	Port F data output latch register	0x00
0x00 501A		PF_IDR	Port F input pin value register	0xXX ⁽¹⁾
0x00 501B		PF_DDR	Port F data direction register	0x00
0x00 501C		PF_CR1	Port F control register 1	0x00
0x00 501D		PF_CR2	Port F control register 2	0x00

1. Depends on the external circuitry.

Table 11. General hardware register map

Address	Block	Register label	Register name	Reset status
0x00 501E to 0x00 5069	Reserved area (60 byte)			
0x00 505A	Flash	FLASH_CR1	Flash control register 1	0x00
0x00 505B		FLASH_CR2	Flash control register 2	0x00
0x00 505C		FLASH_NCR2	Flash complementary control register 2	0xFF
0x00 505D		FLASH_FPR	Flash protection register	0x00
0x00 505E		FLASH_NFPR	Flash complementary protection register	0xFF
0x00 505F		FLASH_IAPSR	Flash in-application programming status register	0x40
0x00 5060 to 0x00 5061	Reserved area (2 byte)			
0x00 5062	Flash	FLASH_PUKR	Flash Program memory unprotection register	0x00
0x00 5063	Reserved area (1 byte)			
0x00 5064	Flash	FLASH_DUKR	Data EEPROM unprotection register	0x00
0x00 5065 to 0x00 509F	Reserved area (59 byte)			
0x00 50A0	ITC	EXTI_CR1	External interrupt control register 1	0x00
0x00 50A1		EXTI_CR2	External interrupt control register 2	0x00
0x00 50A2 to 0x00 50B2	Reserved area (17 byte)			

Table 11. General hardware register map (continued)

Address	Block	Register label	Register name	Reset status
0x00 50B3	RST	RST_SR	Reset status register	0xXX ⁽¹⁾
0x00 50B4 to 0x00 50BF	Reserved area (12 byte)			
0x00 50C0	CLK	CLK_ICKR	Internal clock control register	0x01
0x00 50C1		CLK_ECKR	External clock control register	0x00
0x00 50C2	Reserved area (1 byte)			
0x00 50C3	CLK	CLK_CMSR	Clock master status register	0xE1
0x00 50C4		CLK_SWR	Clock master switch register	0xE1
0x00 50C5		CLK_SWCR	Clock switch control register	0xFF
0x00 50C6		CLK_CKDIVR	Clock divider register	0x18
0x00 50C7		CLK_PCKENR1	Peripheral clock gating register 1	0xFF
0x00 50C8		CLK_CSSR	Clock security system register	0x00
0x00 50C9		CLK_CCOR	Configurable clock control register	0x00
0x00 50CA		CLK_PCKENR2	Peripheral clock gating register 2	0xFF
0x00 50CB	Reserved area (1 byte)			
0x00 50CC	CLK	CLK_HSITRIMR	HSI clock calibration trimming register	0x00
0x00 50CD		CLK_SWIMCCR	SWIM clock control register	0bXXXX XXX0
0x00 50CE to 0x00 50D0	Reserved area (3 byte)			
0x00 50D1	WWDG	WWDG_CR	WWDG control register	0x7F
0x00 50D2		WWDG_WR	WWDG window register	0x7F
0x00 50D3 to 0x00 50DF	Reserved area (13 byte)			
0x00 50E0	IWDG	IWDG_KR	IWDG key register	0xFF ⁽²⁾
0x00 50E1		IWDG_PR	IWDG prescaler register	0x00
0x00 50E2		IWDG_RLR	IWDG reload register	0xFF
0x00 50E3 to 0x00 50EF	Reserved area (13 byte)			
0x00 50F0	AWU	AWU_CSR1	AWU control/status register 1	0x00
0x00 50F1		AWU_APR	AWU asynchronous prescaler buffer register	0x3F
0x00 50F2		AWU_TBR	AWU timebase selection register	0x00
0x00 50F3	BEEP	BEEP_CSR	BEEP control/status register	0x1F
0x00 50F4 to 0x00 50FF	Reserved area (12 byte)			

Table 11. General hardware register map (continued)

Address	Block	Register label	Register name	Reset status
0x00 5300	TIM5	TIM5_CR1	TIM5 control register 1	0x00
0x00 5301		TIM5_CR2	TIM5 control register 2	0x00
0x00 5302		TIM5_SMCR	TIM5 slave mode control register	0x00
0x00 5303		TIM5_IER	TIM5 interrupt enable register	0x00
0x00 5304		TIM5_SR1	TIM5 status register 1	0x00
0x00 5305		TIM5_SR2	TIM5 status register 2	0x00
0x00 5306		TIM5_EGR	TIM5 event generation register	0x00
0x00 5307		TIM5_CCMR1	TIM5 capture/compare mode register 1	0x00
0x00 5308		TIM5_CCMR2	TIM5 capture/compare mode register 2	0x00
0x00 5309		TIM5_CCMR3	TIM5 capture/compare mode register 3	0x00
0x00 530A		TIM5_CCER1	TIM5 capture/compare enable register 1	0x00
0x00 530B		TIM5_CCER2	TIM5 capture/compare enable register 2	0x00
00 530C0x		TIM5_CNTRH	TIM5 counter high	0x00
0x00 530D		TIM5_CNTRL	TIM5 counter low	0x00
0x00 530E		TIM5_PSCR	TIM5 prescaler register	0x00
0x00 530F		TIM5_ARRH	TIM5 auto-reload register high	0xFF
0x00 5310		TIM5_ARRL	TIM5 auto-reload register low	0xFF
0x00 5311		TIM5_CCR1H	TIM5 capture/compare register 1 high	0x00
0x00 5312		TIM5_CCR1L	TIM5 capture/compare register 1 low	0x00
0x00 5313		TIM5_CCR2H	TIM5 capture/compare reg. 2 high	0x00
0x00 5314		TIM5_CCR2L	TIM5 capture/compare register 2 low	0x00
0x00 5315		TIM5_CCR3H	TIM5 capture/compare register 3 high	0x00
0x00 5316		TIM5_CCR3L	TIM5 capture/compare register 3 low	0x00
0x00 5317 to 0x00 533F	Reserved area (43 byte)			
0x00 5340	TIM6	TIM6_CR1	TIM6 control register 1	0x00
0x00 5341		TIM6_CR2	TIM6 control register 2	0x00
0x00 5342		TIM6_SMCR	TIM6 slave mode control register	0x00
0x00 5343		TIM6_IER	TIM6 interrupt enable register	0x00
0x00 5344		TIM6_SR	TIM6 status register	0x00
0x00 5345		TIM6_EGR	TIM6 event generation register	0x00
0x00 5346		TIM6_CNTR	TIM6 counter	0x00
0x00 5347		TIM6_PSCR	TIM6 prescaler register	0x00
0x00 5348		TIM6_ARR	TIM6 auto-reload register	0xFF

Table 11. General hardware register map (continued)

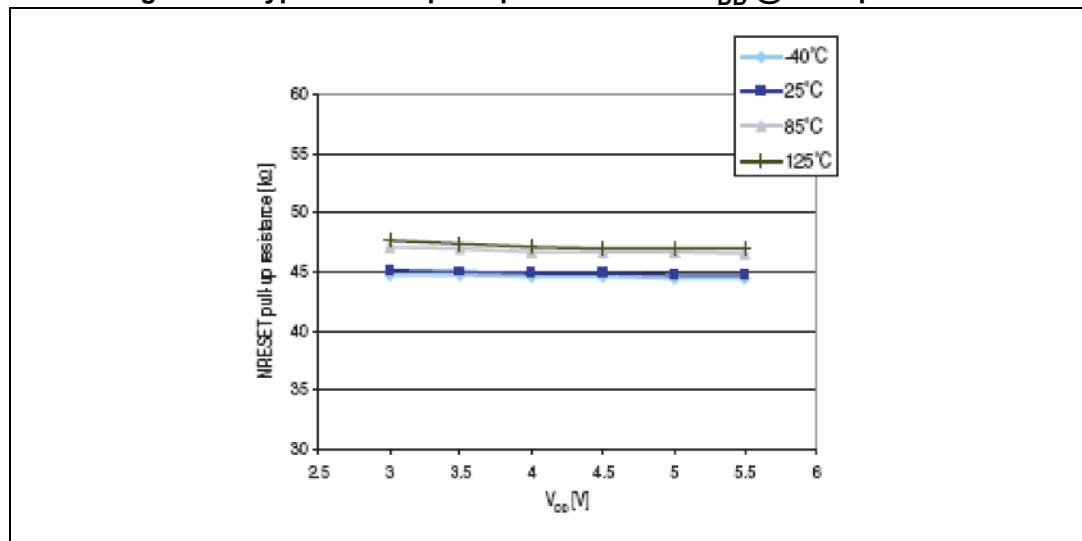
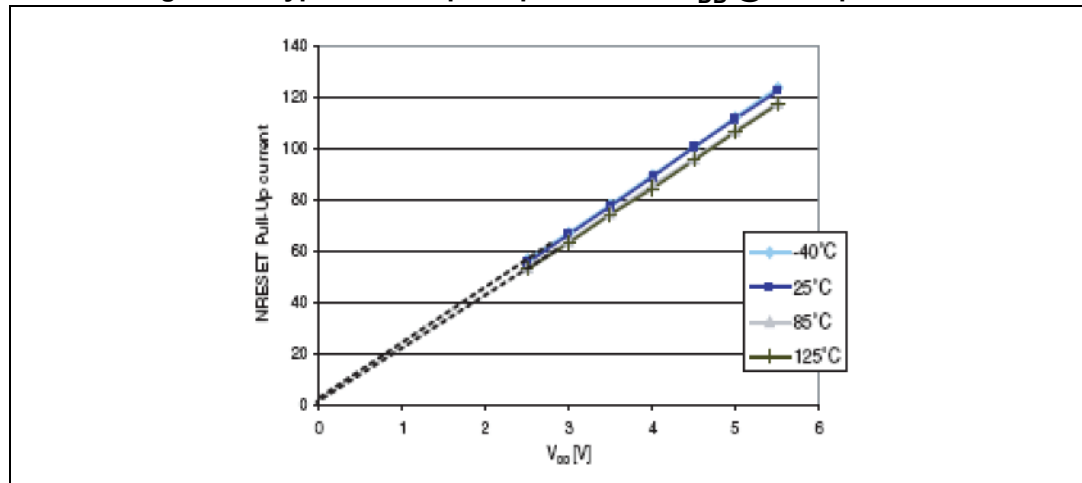
Address	Block	Register label	Register name	Reset status
0x00 5349 to 0x00 53DF	Reserved area (153 byte)			
0x00 53E0 to 0x00 53F3	ADC1	ADC_DBxR	ADC data buffer registers	0x00
0x00 53F4 to 0x00 53FF	Reserved area (12 byte)			
0x00 5400	ADC1	ADC_CSR	ADC control/status register	0x00
0x00 5401		ADC_CR1	ADC configuration register 1	0x00
0x00 5402		ADC_CR2	ADC configuration register 2	0x00
0x00 5403		ADC_CR3	ADC configuration register 3	0x00
0x00 5404		ADC_DRH	ADC data register high	0xFF
0x00 5405		ADC_DRL	ADC data register low	0xFF
0x00 5406		ADC_TDRH	ADC Schmitt trigger disable register high	0x00
0x00 5407		ADC_TDRL	ADC Schmitt trigger disable register low	0x00
0x00 5408		ADC_HTRH	ADC high threshold register high	0xFF
0x00 5409		ADC_HTRL	ADC high threshold register low	0x03
0x00 540A		ADC_LTRH	ADC low threshold register high	0x00
0x00 540B		ADC_LTRL	ADC low threshold register low	0x00
0x00 540C		ADC_AWSRH	ADC watchdog status register high	0x00
0x00 540D		ADC_AWSRL	ADC watchdog status register low	0x00
0x00 540E		ADC_AWCRH	ADC watchdog control register high	0x00
0x00 540F		ADC_AWCRL	ADC watchdog control register low	0x00
0x00 5410 to 0x00 57FF	Reserved area (1008 byte)			

1. Depends on the previous reset source.
2. Write only register.

7 Interrupt vector mapping

Table 13. Interrupt mapping

Priority	Source block	Description	Wakeup from halt mode	Wakeup from active-halt mode	Interrupt vector address
—	Reset	Reset	Yes	Yes	0x00 8000
—	TRAP	Software interrupt	-	-	0x00 8004
0	TLI	External top level interrupt	-	-	0x00 8008
1	AWU	Auto-wakeup from Halt	-	Yes	0x00 800C
2	Clock controller	Clock controller	-	-	0x00 8010
3	EXTI0	Port A external interrupts	Yes ⁽¹⁾	Yes ⁽¹⁾	0x00 8014
4	EXTI1	Port B external interrupts	Yes	Yes	0x00 8018
5	EXTI2	Port C external interrupts	Yes	Yes	0x00 801C
6	EXTI3	Port D external interrupts	Yes	Yes	0x00 8020
7	EXTI4	Port E external interrupts	Yes	Yes	0x00 8024
8	EXTI5	Port F	-	-	0x00 8028
9	Reserved	-	-	-	0x00 802C
10	SPI	End of transfer	Yes	Yes	0x00 8030
11	TIM1	TIM1 update/overflow/underflow/trigger/break	-	-	0x00 8034
12	TIM1	TIM1 capture/compare	-	-	0x00 8038
13	TIM5	TIM5 update/overflow/trigger	-	-	0x00 803C
14	TIM5	TIM5 capture/compare	-	-	0x00 8040
15	Reserved	-	-	-	0x00 8044
16	Reserved	-	-	-	0x00 8048
17	LINUART	Tx complete	-	-	0x00 804C
18	LINUART	Receive register DATA FULL	-	-	0x00 8050
19	I ² C	I ² C interrupts	Yes	Yes	0x00 8054
20	Reserved	-	-	-	0x00 8058
21	Reserved	-	-	-	0x00 805C
22	ADC1	ADC1 end of conversion/analog watchdog interrupt	-	-	0x00 8060

Figure 33. Typical NRST pull-up resistance vs V_{DD} @ 4 temperaturesFigure 34. Typical NRST pull-up current vs V_{DD} @ 4 temperatures

The reset network shown in [Figure 35](#) protects the device against parasitic resets. The user must ensure that the level on the NRST pin can go below $V_{IL(NRST)}$ max (see [Table 51: NRST pin characteristics](#)), otherwise the reset is not taken into account internally.

For power consumption sensitive applications, the external reset capacitor value can be reduced to limit the charge/discharge current. If NRST signal is used to reset external circuitry, attention must be taken to the charge/discharge time of the external capacitor to fulfill the external devices reset timing conditions. Minimum recommended capacity is 100 nF.

9.3.10 10-bit ADC characteristics

Subject to general operating conditions for V_{DD} , f_{MASTER} , and T_A unless otherwise specified.

Table 54. ADC characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
f _{ADC}	ADC clock frequency	V _{DD} = 3 to 5.5 V	1	-	4	MHz
		V _{DD} = 4.5 to 5.5 V	1	-	6	
V _{AIN}	Conversion voltage range ⁽¹⁾	-	V _{SS}	-	V _{DD}	V
V _{BGREF}	Internal bandgap reference voltage	V _{DD} = 3 to 5.5 V	1.19 ⁽²⁾	1.22	1.25 ⁽²⁾	V
C _{ADC}	Internal sample and hold capacitor	-	-	3	-	pF
t _S ⁽¹⁾	Minimum sampling time	f _{ADC} = 4MHz	-	0.75	-	μs
		f _{ADC} = 6 MHz	-	0.5	-	
t _{STAB}	Wakeup time from standby	-	-	7	-	
t _{CONV}	Minimum total conversion time including sampling time, 10-bit resolution	f _{ADC} = 4 Hz	3.5			μs
		f _{ADC} = 6 MHz	2.33			
		-	14			1/f _{ADC}

1. During the sample time the input capacitance C_{AIN} (3 pF max) can be charged/discharged by the external source. The internal resistance of the analog source must allow the capacitance to reach its final voltage level within t_S . After the end of the sample time t_S , changes of the analog input voltage have no effect on the conversion result. Values for the sample clock t_S depend on programming.

2. Tested in production.

Static latch-up

Two complementary static tests are required on six parts to assess the latch-up performance:

- A supply overvoltage (applied to each power supply pin),
- A current injection (applied to each input, output and configurable I/O pin) are performed on each sample.

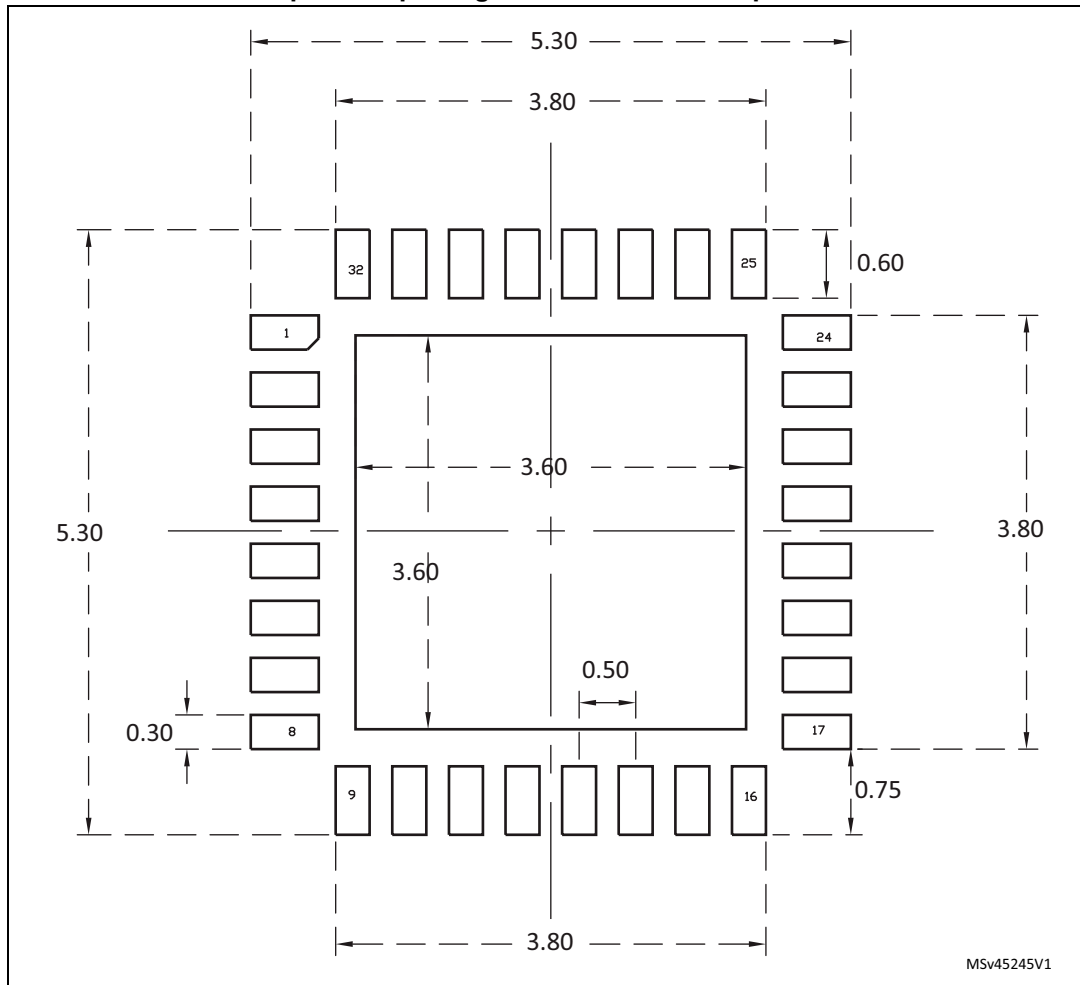
This test conforms to the EIA/JESD 78 IC latch-up standard. For more details, refer to the application note AN1181.

Table 60. Electrical sensitivities

Symbol	Parameter	Conditions	Class ⁽¹⁾
LU	Static latch-up class	$T_A = 25\text{ °C}$	A
		$T_A = 85\text{ °C}$	
		$T_A = 125\text{ °C}$	
		$T_A = 150\text{ °C}$	

1. Class description: A Class is an STMicroelectronics internal specification. All its limits are higher than the JEDEC specifications, that means when a device belongs to class A it exceeds the JEDEC standard. B class strictly covers all the JEDEC criteria (international standard).

Figure 49. VFQFPN32 - 32-pin, 5x5 mm, 0.5 mm pitch very thin profile fine pitch quad flat package recommended footprint



1. Dimensions are expressed in millimeters.

13 Revision history

Table 66. Document revision history

Date	Revision	Changes
11-Oct-2013	1	Initial release.
16-Dec-2013	2	Changed the document status to Production data. Updated <i>Figure: STM8AF6223PxAx TSSOP20 pinout</i> to add SPI_NSS to PD4, TLI to PD2, and change remap function on PB5 from TIM5_BKIn to TIM1_BKIN. Updated <i>Table: STM8AF6223PxAx TSSOP20 pin description</i> to add SPI_NSS to PD4 and TLI to PD2. Updated <i>Table: STM8AF6223 TSSOP20 pin description</i> and <i>Table: LQFP32 pin description</i>. Updated AFR2 definition in <i>Table: STM8AF6223PxAx alternate function remapping bits [7:2] for 20-pin packages</i>. Removed the remapping option on PA3 for AFR[1:0]=10 in <i>Table: STM8AF6223PxAx alternate function remapping bits [1:0] for 20-pin packages</i>. Added note and removed remapping option on PA3 for AFR[1:0]=11 in <i>Table: STM8AF6223 alternate function remapping bits [1:0] for 20-pin packages</i>. Updated AFR2 definition in STM8AF6223 alternate function remapping bits [7:2] for 20-pin packages. Added the note below <i>Table: STM8AF6226T alternate function remapping bits [1:0] for 32-pin packages</i>. Updated <i>Table: I2C characteristics</i> to modify $t_{h(SDA)}$ and add t_{SP}. Updated <i>Section: C assembly toolchains</i>.
03-Apr-2014	3	Replaced STM8AF6226T by STM8AF6226 part number. Added STM8AF6223A part number to cover STM8AF6223PxAx order codes. Removed LINUART alternate function for PA3 in <i>Table: STM8AF6223PxAx TSSOP20 pin description</i>. Removed note 3 for $I_{DD(AH)}$ in <i>Table: Total current consumption in active halt mode at VDD = 5 V</i>. Updated the remapping option on PA3 for AFR[1:0]=11 in <i>Table: STM8AF6223 alternate function remapping bits [1:0] for 20-pin packages</i>. Updated notes related to t_{RET} minimum value in <i>Table: Data memory</i>. Updated <i>Table: ESD absolute maximum ratings</i>. Added notes related to protrusions and gate burrs for D and E1 dimensions in <i>Table: 20-pin, 4.40 mm body, 0.65 mm pitch mechanical data</i>.